



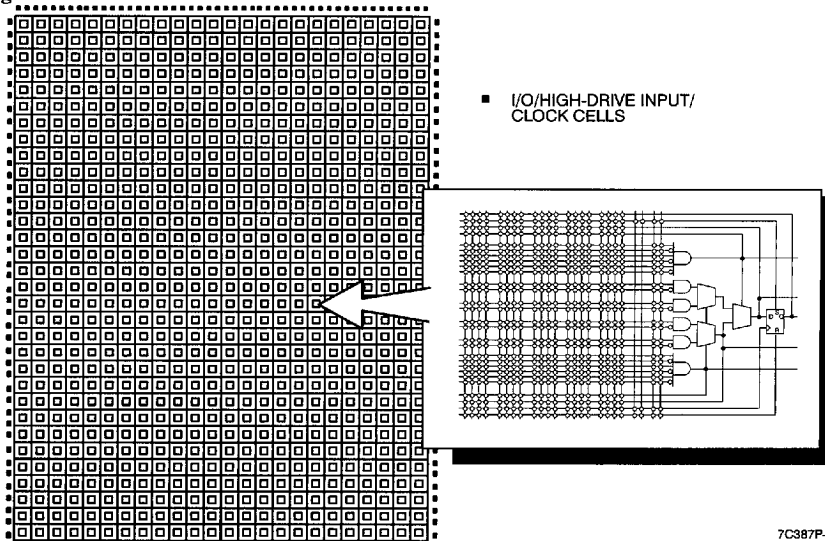
CY7C387P
CY7C388P

UltraLogic™ Very High Speed 8K Gate CMOS FPGA

Features

- **Very high speed**
 - Loadable counter frequencies greater than 150 MHz
 - Chip-to-chip operating frequencies up to 110 MHz
 - Input + logic cell + output delays under 6 ns
- **Unparalleled FPGA performance for counters, data path, state machines, arithmetic, and random logic**
- **High usable density**
 - 24 x 32 array of 768 logic cells provides 24,000 total available gates
 - 8,000 typically usable "gate array" gates in 144-pin TQFP, 208-pin PQFP and CQFP, and 223-pin CPGA packages
- **Fully PCI compliant inputs & outputs for commercial and industrial temperature ranges**
- **Low power, high output drive**
 - Standby current typically 2 mA
 - 16-bit counter operating at 100 MHz consumes 50 mA
 - Minimum I_{OL} and I_{OH} of 20 mA (PCI compliant)
- **Flexible logic cell architecture**
 - Wide fan-in (up to 14 input gates)
 - Multiple outputs in each cell
 - Very low cell propagation delay (1.7 ns typical)
- **Powerful design tools—Warp3™**
 - Designs entered in IEEE 1164 VHDL, schematics, or mixed mode
 - Fast, fully automatic place and route
 - Waveform simulation with back-annotated net delays
 - PC and workstation platforms
- **Extensive third-party tool support**
 - See Development Systems section
- **Robust routing resources**
 - Fully automatic place and route of designs using up to 100 percent of logic resources
 - No hand routing required
- **116 (7C387P) to 172 (7C388P) bidirectional input/output pins**
- **6 dedicated input/high-drive pins**
- **2 clock/dedicated input pins with fan-out-independent, low-skew nets**
 - Clock skew <0.5 ns
- **Input hysteresis provides high noise immunity**
- **Thorough testability**
 - Built-in scan path permits 100 percent factory testing of logic and I/O cells
- **0.65μ CMOS process with ViaLink™ programming technology**
 - High-speed metal-to-metal link
 - Non-volatile antifuse technology
- **144-pin TQFP is compatible with the 4K (CY7C386P) FPGAs**

Logic Block Diagram



144, 160, 208, and 223 PIN PACKAGES, 172 I/O CELLS, 6 INPUT HIGH DRIVE CELLS, 2 INPUT/CLK (HIGH DRIVE) CELLS

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Functional Description

The CY7C387P and CY7C388P are very high speed, CMOS, user-programmable ASIC (pASIC™) devices. The 768 logic cell field-programmable gate array (FPGA) offers 8,000 typically usable "gate array" gates. This is equivalent to 24,000 EPLD or LCA gates. The CY7C387P is available in 208-pin CQFP and 144-pin TQFP. The CY7C388P is available in 208-pin PQFP and a 223-pin CPGA.

Low-impedance, metal-to-metal ViaLink interconnect technology provides non-volatile custom logic capable of operating at speeds above 150 MHz with input delays under 1.5 ns and output delays

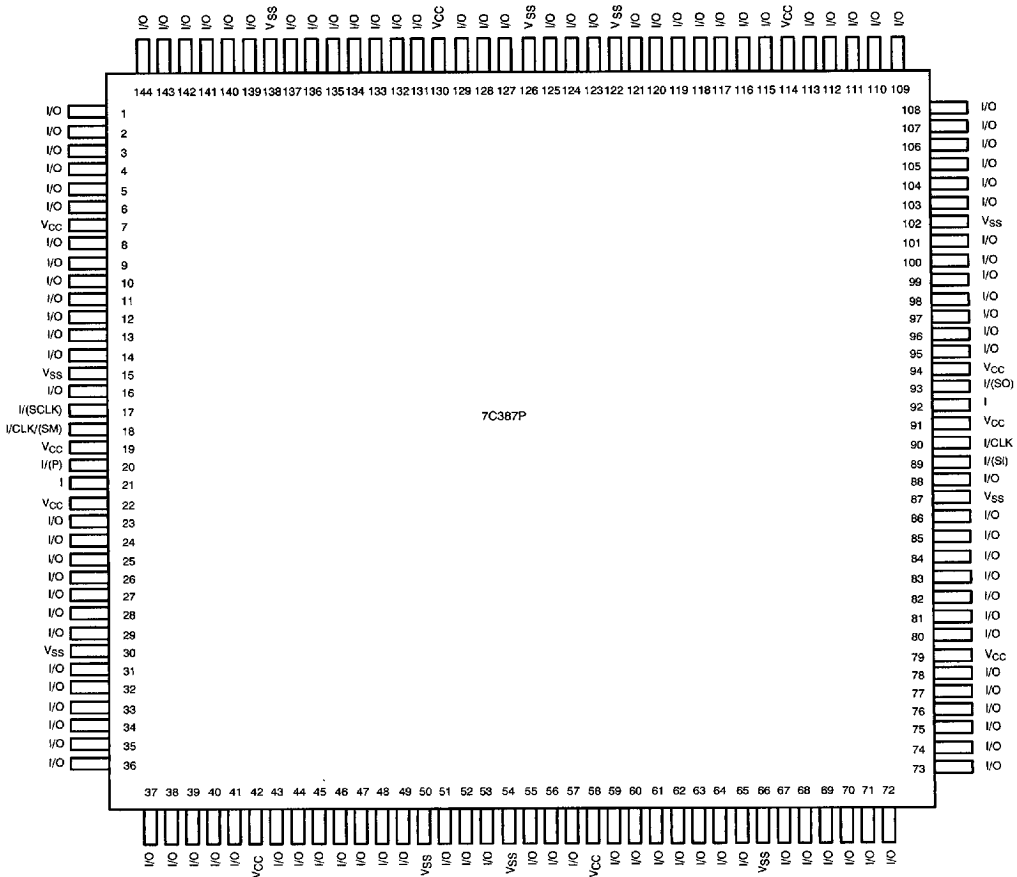
under 3 ns. This permits high-density programmable devices to be used with today's fastest CISC and RISC microprocessors.

Designs are captured for the CY7C387P and CY7C388P using Cypress *Warp3* software or one of several third-party tools. See the Development Systems section of the *Programmable Logic Data-book* for more tools information. *Warp3* is a sophisticated CAE package that features schematic entry, waveform-based timing simulation, and VHDL design synthesis. The CY7C387P and CY7C388P feature ample on-chip routing channels for fast, fully automatic place and route of high gate utilization designs.

For detailed information about the pASIC380 architecture, see the pASIC380 Family datasheet.

Pin Configurations

144-Pin Thin Quad Flat Pack (TQFP)
Top View

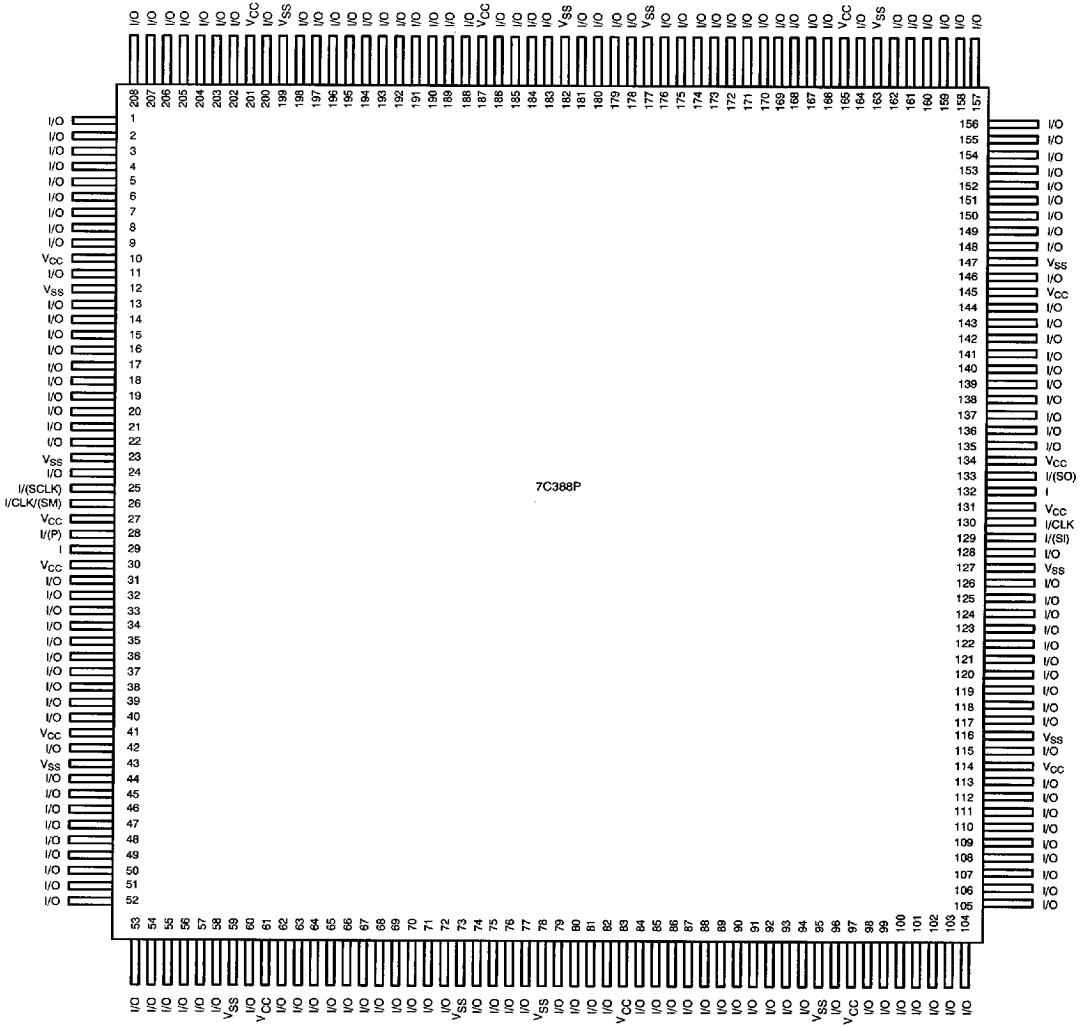


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Pin Configurations (continued)

208-Pin Plastic Quad Flat Pack (PQFP) and
208-Pin Ceramic Quad Flat Pack (CQFP)

Top View



7C387P-3

Pin Configurations (continued)
223-Pin CPGA
Bottom View

NC	NC	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC	NC	V							
NC	NC	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC	NC	U							
I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC	NC	T							
I/O	I/O	I/O	I/O	I/O	I/O	V _{CC}	V _{SS}	V _{CC}	V _{SS}	V _{CC}	V _{SS}	I/O	I/O	I/O	I/O	I/O	I/O	R							
I/O	I/O	I/O	I/O	7C388P										I/O	I/O	I/O	I/O	P							
I/O	I/O	I/O	I/O											I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	N
I/O	I/O	I/O	V _{SS}											V _{CC}	I/O	I/O	I/O	I/O	M						
I/O	I/O	I/O	V _{CC}											V _{SS}	I/O	I/O	I/O	I/O	L						
I/CLK	I/(SI)	I/O	V _{SS}											V _{CC}	I/(P)	I	I/O	K							
I/O	I/(SO)	I	V _{CC}											V _{SS}	I/O	I/SCLK	I/CLK/(SM)	J							
I/O	I/O	I/O	V _{SS}											V _{CC}	I/O	I/O	I/O	H							
I/O	I/O	I/O	V _{CC}											V _{SS}	I/O	I/O	I/O	G							
I/O	I/O	I/O	I/O											I/O	I/O	I/O	I/O	F							
I/O	I/O	I/O	I/O											I/O	I/O	I/O	I/O	E							
I/O	I/O	I/O	I/O	I/O	I/O	V _{SS}	V _{CC}	V _{SS}	V _{CC}	V _{SS}	V _{CC}	I/O	I/O	I/O	I/O	I/O	I/O	D							
NC	NC	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	C							
NC	NC	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC	NC	B							
NC	NC	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC	NC	A							
18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1								

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Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	
Ceramic	-65°C to +150°C
Plastic	-40°C to +125°C
Lead Temperature	300°C
Supply Voltage	-0.5V to +7.0V
Input Voltage	-0.5V to V _{CC} + 0.5V
ESD Pad Protection	±2000 V
DC Input Voltage	-0.5V to 7.0V

DC Input Current	±20mA
Latch-Up Current	±200 mA

Operating Range

Range	Ambient Temperature	V _{CC}
Commercial	0°C to +70°C	5V ± 5%
Industrial	-40°C to +85°C	5V ± 10%
Military	-55°C to +125°C	5V ± 10%

Delay Factor (K)

Speed Grade	Commercial		Industrial		Military	
	Min.	Max.	Min.	Max.	Min.	Max.
-X	0.46	2.55	0.4	2.75	0.39	3.00
-0	0.46	1.55	0.4	1.67	0.39	1.82
-1	0.46	1.33	0.4	1.43	0.39	1.56
-2	0.46	1.25	0.4	1.35		

Shaded area contains preliminary information.

Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	I _{OH} = -10 mA	3.7		V
		I _{OH} = -20 mA	2.4		V
		I _{OH} = -10.0 μA	V _{CC} - 0.1		V
V _{OL}	Output LOW Voltage	I _{OL} = 20 mA		0.4	V
		I _{OL} = 10.0 μA		0.1	V
V _{IH}	Input HIGH Voltage		2.0		V
V _{IL}	Input LOW Voltage			0.8	V
I _I	Input Leakage Current	V _{IN} = V _{CC} or V _{SS}	-10	+10	μA
I _{OZ}	Three-State Output Leakage Current	V _{IN} = V _{CC} or V _{SS}	-10	+10	μA
I _{OS}	Output Short Circuit Current ^[1]	V _{OUT} = V _{SS}	-10	-90	mA
		V _{OUT} = V _{CC}	40	160	mA
I _{CC1}	Standby Supply Current	V _{IN} , V _{I/O} = V _{CC} or V _{SS}		10	mA

Capacitance

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	T _A = 25°C, f = 1 MHz, V _{CC} = 5.0V	10	pF
C _{OUT}	Output Capacitance		10	pF

Note:

1. Only one output at a time. Duration should not exceed 30 seconds.

Switching Characteristics ($V_{CC}=5V$, $T_A=25^\circ C$, $K = 1.00$)

Parameter	Description	Propagation Delays ^[2] with Fanout of					Unit
		1	2	3	4	8	
LOGIC CELLS							
t_{PD}	Combinatorial Delay ^[3]	1.7	2.2	2.7	3.3	5.5	ns
t_{SU}	Set-Up Time ^[3]	2.1	2.1	2.1	2.1	2.1	ns
t_H	Hold Time	0.0	0.0	0.0	0.0	0.0	ns
t_{CLK}	Clock to Q Delay	1.0	1.5	1.9	2.7	4.9	ns
t_{CWHI}	Clock HIGH Time	2.0	2.0	2.0	2.0	2.0	ns
t_{CWLO}	Clock LOW Time	2.0	2.0	2.0	2.0	2.0	ns
t_{SET}	Set Delay	1.7	2.2	2.7	3.3	5.5	ns
t_{RESET}	Reset Delay	1.5	1.9	2.3	2.8	4.6	ns
t_{SW}	Set Width	1.9	1.9	1.9	1.9	1.9	ns
t_{RW}	Reset Width	1.8	1.8	1.8	1.8	1.8	ns

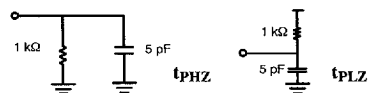
Parameter	Description	Propagation Delays ^[2] with Fanout of							Unit
		1	2	3	4	8	12	16	
INPUT CELLS									
t_{IN}	Input Delay (HIGH Drive)	3.1	3.2	3.3	3.4	4.4	5.8	6.5	ns
t_{INI}	Input, Inverting Delay (HIGH Drive)	3.3	3.4	3.5	3.6	4.6	6.0	6.7	ns
t_{IO}	Input Delay (Bidirectional Pad)	1.4	1.9	2.3	3.0	4.8	6.7	8.5	ns
t_{GCK}	Clock Buffer Delay ^[4]	2.7	2.8	2.9	3.0	3.1	3.3	3.4	ns
t_{GCKHI}	Clock Buffer Min. HIGH ^[4]	2.0	2.0	2.0	2.0	2.0	2.0	2.0	ns
t_{GCKLO}	Clock Buffer Min. LOW ^[4]	2.0	2.0	2.0	2.0	2.0	2.0	2.0	ns

Parameter	Description	Propagation Delays ^[2] with Output Load Capacitance (pF) of					Unit
		30	50	75	100	150	
OUTPUT CELLS							
t_{OUTLH}	Output Delay LOW to HIGH	2.7	3.3	3.8	4.3	5.4	ns
t_{OUTH}	Output Delay HIGH to LOW	2.8	3.6	4.5	5.3	6.9	ns
t_{PZH}	Output Delay Three-State to HIGH	2.1	2.6	3.1	3.7	4.8	ns
t_{PZL}	Output Delay Three-State to LOW	2.6	3.3	4.1	4.9	6.5	ns
t_{PHZ}	Output Delay HIGH to Three-State ^[5]	2.9					ns
t_{PLZ}	Output Delay LOW to Three-State ^[5]	3.3					ns

Notes:

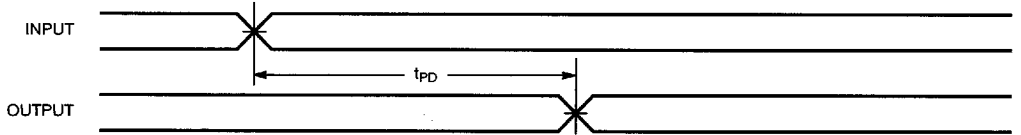
- Worst-case propagation delay times over process variation at $V_{CC} = 5.0V$ and $T_A = 25^\circ C$. Multiply by the appropriate delay factor, K , for speed grade to get worst-case parameters over full V_{CC} and temperature range as specified in the operating range. All inputs are TTL with 3-ns linear transition time between 0 and 3 volts.
- These limits are derived from worst-case values for a representative selection of the slowest paths through the pASIC380 logic cell including net delays. Guaranteed delay values for specific paths should be determined from simulation results.

- Clock buffer fanout refers to the maximum number of flip-flops per half column. The number of half columns used does not affect clock buffer delay.
- The following loads are used for t_{PXZ} :

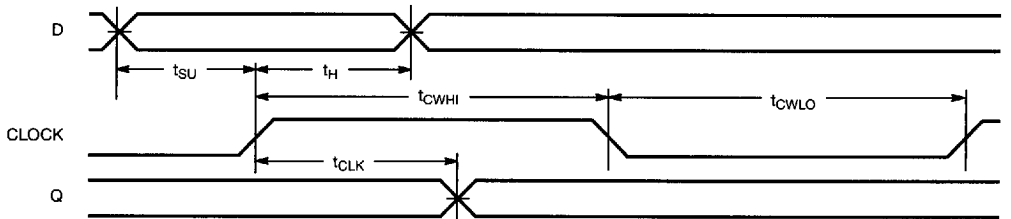


High Drive Buffer

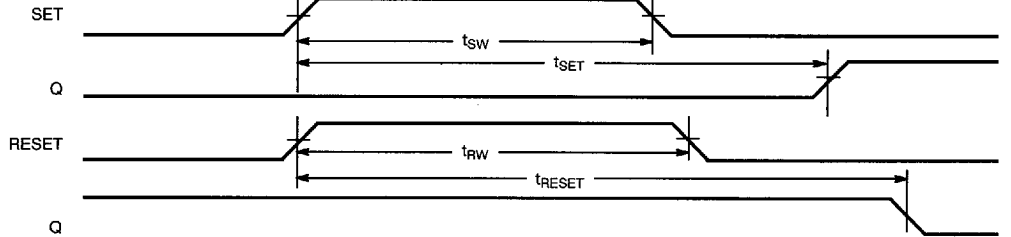
Parameter	Description	# High Drives Wired Together	Propagation Delays ^[2] with Fanout of					Unit
			12	24	48	72	96	
t_{IN}	High Drive Input Delay	1	5.8	7.2				ns
		2		5.0	7.1			ns
		3			5.8	6.7	7.7	ns
		4				5.9	6.8	ns
t_{NI}	High Drive Input, Inverting Delay	1	6.0	7.4				ns
		2		5.2	7.3			ns
		3			6.0	6.9	7.9	ns
		4				6.1	7.0	ns

Switching Waveforms
Combinatorial Delay


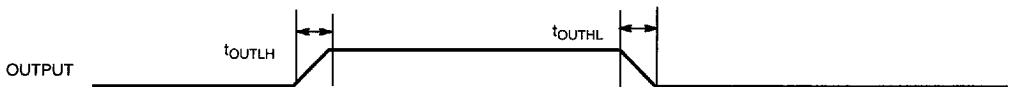
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Set-Up and Hold Times


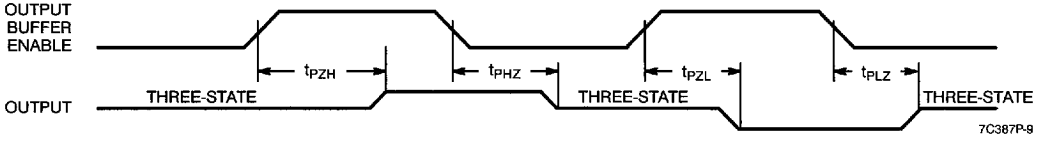
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Set and Reset Delays


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Output Delay


7C387P-8

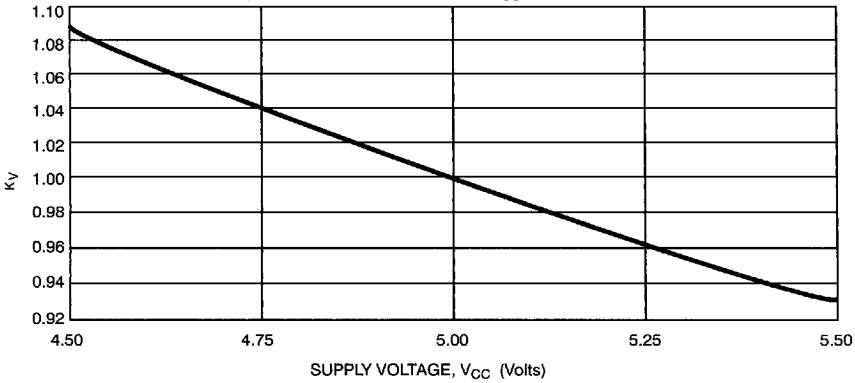
Switching Waveforms (continued)
Three-State Delay


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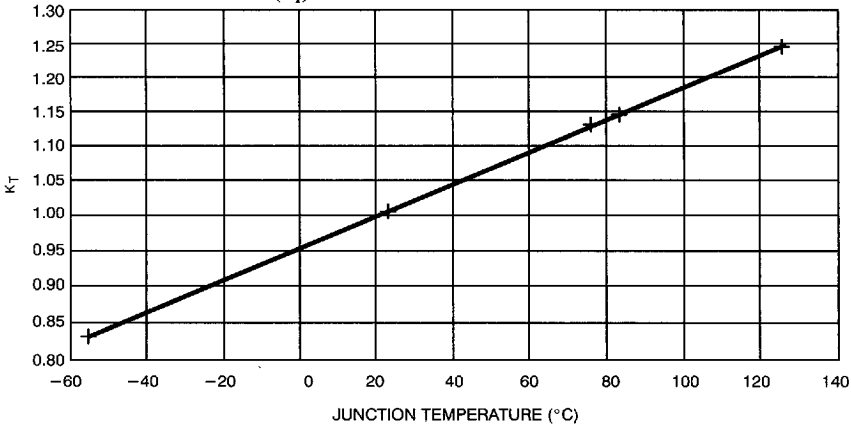
Typical AC Characteristics

Propagation delays depend on routing, fanout, load capacitance, supply voltage, junction temperature, and process variation. The AC Characteristics are a design guide to provide initial timing estimates at nominal conditions. Worst-case estimates are obtained when nominal propagation delays are multiplied by the appropriate

Delay Factor, K, as specified by the speed grade in the Delay Factor table. The effects of voltage and temperature variation are illustrated in the graphs below. The *Warp3* Delay Modeler extracts specific timing parameters for precise simulation results following place and route.

VOLTAGE FACTOR (K_V) VERSUS SUPPLY VOLTAGE (V_{CC})


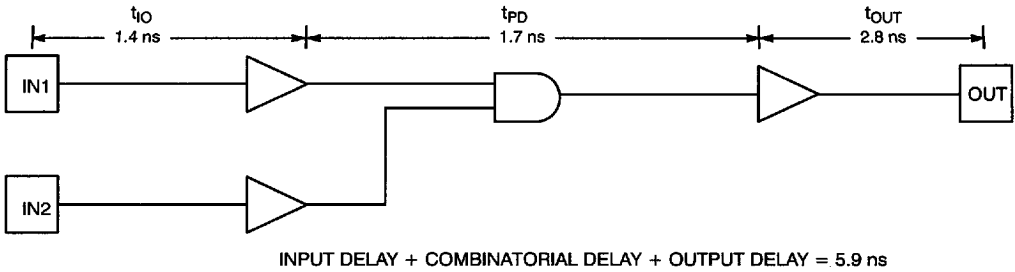
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TEMPERATURE FACTOR (K_T) VERSUS TEMPERATURE


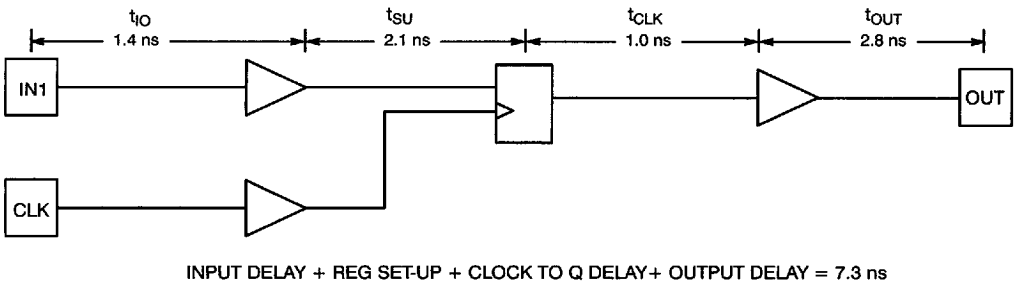
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 * $\theta_{JA} = 45^{\circ}C/WATT$ FOR PLCC

Combinatorial Delay Example (Load = 30 pF, Fanout = 1, K = 1.0)



Sequential Delay Example (Load = 30 pF, Fanout = 1, K = 1.0)



Ordering Information

Speed Grade	Ordering Code	Package Name	Package Type	Operating Range
2	CY7C387P-2AC	A144	144-Pin Thin Quad Flat Pack	Commercial
	CY7C387P-2AI	A144	144-Pin Thin Quad Flat Pack	Industrial
1	CY7C387P-1AC	A144	144-Pin Thin Quad Flat Pack	Commercial
	CY7C387P-1AI	A144	144-Pin Thin Quad Flat Pack	Industrial
0	CY7C387P-0AC	A144	144-Pin Thin Quad Flat Pack	Commercial
	CY7C387P-0AI	A144	144-Pin Thin Quad Flat Pack	Industrial
X	CY7C387P-XAC	A144	144-Pin Thin Quad Flat Pack	Commercial
	CY7C387P-XAI	A144	144-Pin Thin Quad Flat Pack	Industrial

Speed Grade	Ordering Code	Package Name	Package Type	Operating Range
2	CY7C388P-2NC	N208	208-Pin Plastic Quad Flat Pack	Commercial
	CY7C388P-2NI	N208	208-Pin Plastic Quad Flat Pack	Industrial
1	CY7C388P-1NC	N208	208-Pin Plastic Quad Flat Pack	Commercial
	CY7C388P-1NI	N208	208-Pin Plastic Quad Flat Pack	Industrial
	CY7C388P-1GMB	G223	223-Pin Ceramic Pin Grid Array	Military
0	CY7C388P-1UMB	U208	208-Pin Ceramic Quad Flat Pack	Military
	CY7C388P-0NC	N208	208-Pin Plastic Quad Flat Pack	Commercial
	CY7C388P-0NI	N208	208-Pin Plastic Quad Flat Pack	Industrial
	CY7C388P-0GMB	G223	223-Pin Ceramic Pin Grid Array	Military
	CY7C388P-0UMB	U208	208-Pin Ceramic Quad Flat Pack	Military
X	CY7C388P-XNC	N208	208-Pin Plastic Quad Flat Pack	Commercial
	CY7C388P-XNI	N208	208-Pin Plastic Quad Flat Pack	Industrial
	CY7C388P-XGMB	G223	223-Pin Ceramic Pin Grid Array	Military
	CY7C388P-XUMB	U208	208-Pin Ceramic Quad Flat Pack	Military

Shaded area contains preliminary information.

Military Specifications
Group A Subgroup Testing
DC Characteristics

Parameters	Subgroups
V _{OH}	1, 2, 3
V _{OL}	1, 2, 3
I _{OZ}	1, 2, 3
I _{CC1}	1, 2, 3

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